AN7513

1-W BTL audio power amplifier

■ Overview

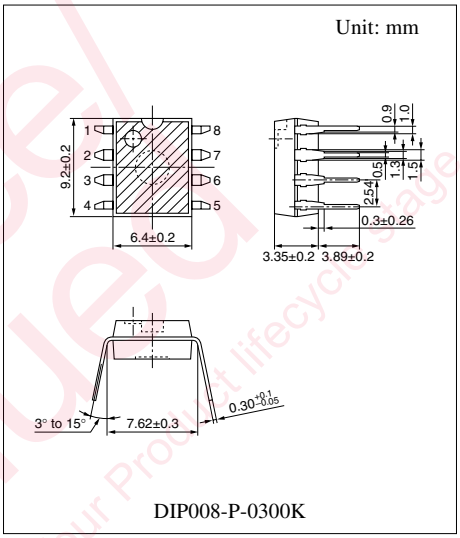
The AN7513 is an audio power amplifier IC with 1-ch output. The BTL (Balanced Transformer-Less) method can provide fewer external parts and more easy design for applications.

■ Features

- 1-W output (8 Ω) with supply voltage of 5 V
- On-chip standby function
- On-chip volume function

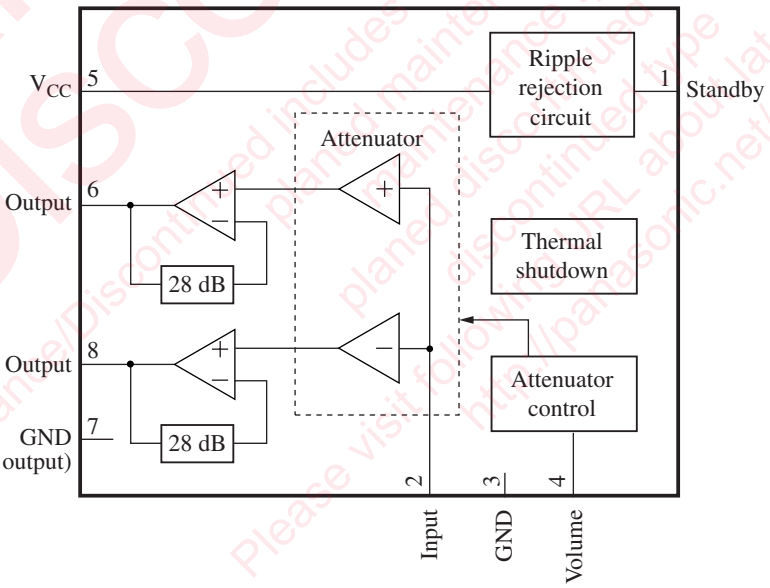
■ Applications

- Televisions, radios, and personal computers



DIP008-P-0300K

■ Block Diagram



■ Pin Descriptions

Pin No.	Description
1	Standby (standby state if this pin is open.)
2	Input
3	Ground (for input)
4	Volume (max. volume if this pin is open.)
5	Supply voltage
6	+ Output
7	Ground (for output ch.1)
8	– Output

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage *2	V_{CC}	14	V
Supply current	I_{CC}	1.0	A
Power dissipation *3	P_D	541	mW
Operating ambient temperature *1	T_{opr}	–25 to +70	°C
Storage temperature *1	T_{stg}	–55 to +150	°C

Note) ∗1: Except for the operating ambient temperature and storage temperature, all ratings are for T_a = 25°C.
∗2: At no signal
∗3: The power dissipation shown is the value for T_a = 70°C.

■ Recommended Operating Range

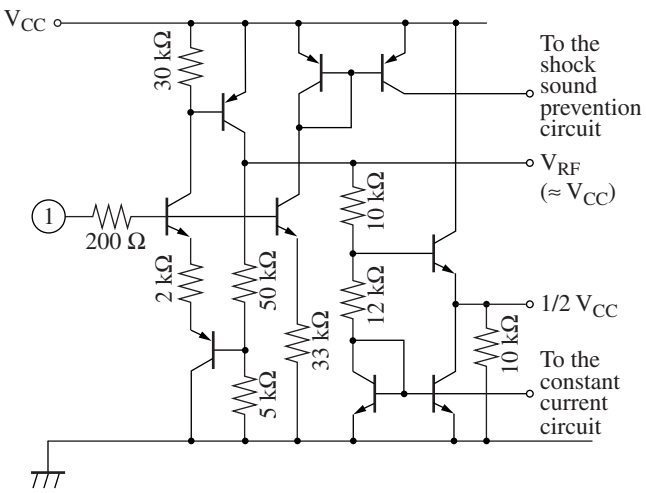
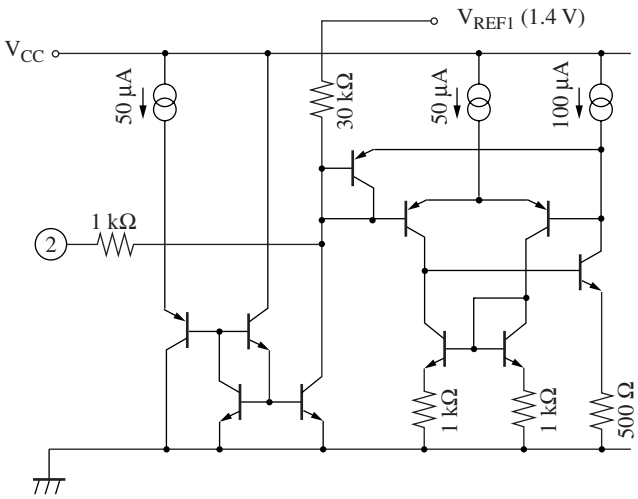
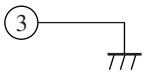
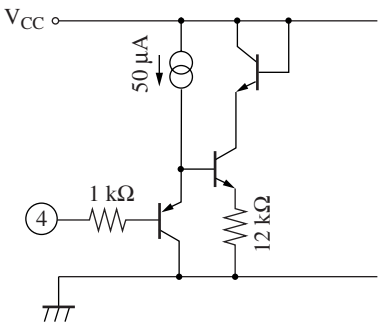
Parameter	Symbol	Range	Unit
Supply voltage	V_{CC}	3.5 to 13.5	V

■ Electrical Characteristics at V_{CC} = 5.0 V, R_L = 8 Ω, f = 1 kHz, T_a = 25°C ± 2°C

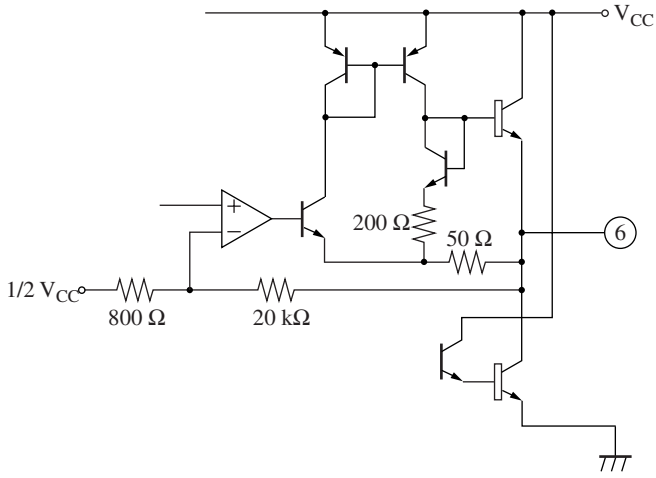
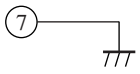
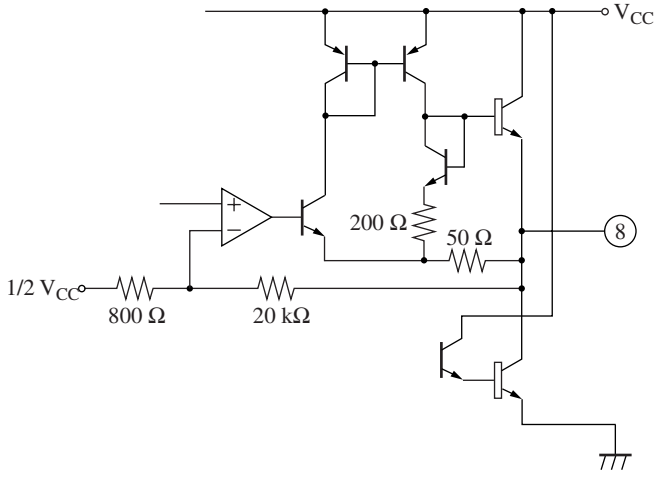
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Quiescent circuit current	I_{CQ}	V_{IN} = 0 mV, Vol. = 0 V	—	20	60	mA
Standby current	I_{STB}	V_{IN} = 0 mV, Vol. = 0 V	—	1	10	µA
Output noise voltage *	V_{NO}	R_g = 10 kΩ, Vol. = 0 V	—	0.10	0.4	mV[rms]
Voltage gain	G_V	P_O = 0.25 W, Vol. = 1.25 V	31	33	35	dB
Total harmonic distortion	THD	P_O = 0.25 W, Vol. = 1.25 V	—	0.10	0.5	%
Maximum output power	P_{O1}	THD = 10%, Vol. = 1.25 V	0.7	1.0	—	W
Ripple rejection ratio *	RR	R_g = 10 kΩ, Vol. = 0 V, V_R = 0.5 V[rms], f_R = 120 Hz	30	50	—	dB
Output offset voltage	V_{OFF}	R_g = 10 kΩ, Vol. = 0 V	–250	0	250	mV
Volume attenuation rate *	Att	P_O = 0.25 W, Vol. = 0 V	70	85	—	dB
Intermediate voltage gain	G_{VM}	P_O = 0.25 W, Vol. = 0.6 V	20.5	23.5	26.5	dB

Note) ∗: In measuring, the filter for the range of 15 Hz to 30 kHz (12 dB/OCT) is used.

■ Terminal Equivalent Circuits

Pin No.	Pin name	Equivalent circuit	Voltage
1	Standby pin		5 V
2	Input pin		1.4 V
3	GND		0 V
4	Volume pin		—

■ Terminal Equivalent Circuits (continued)

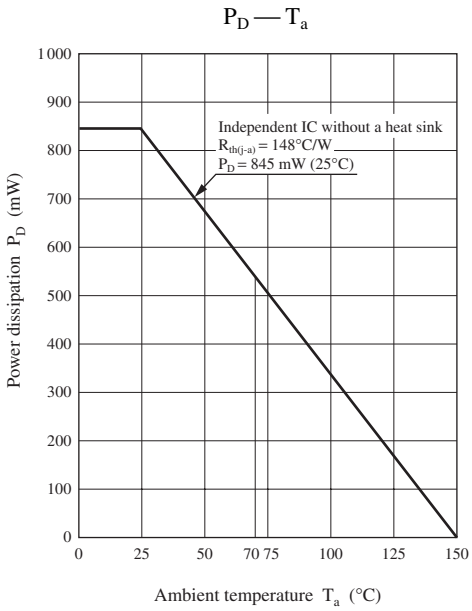
Pin No.	Pin name	Equivalent circuit	Voltage
5	V_{CC}	—	5.0 V
6	+ Output pin		2.15 V
7	GND		0 V
8	– Output pin		2.15 V

■ Usage Notes

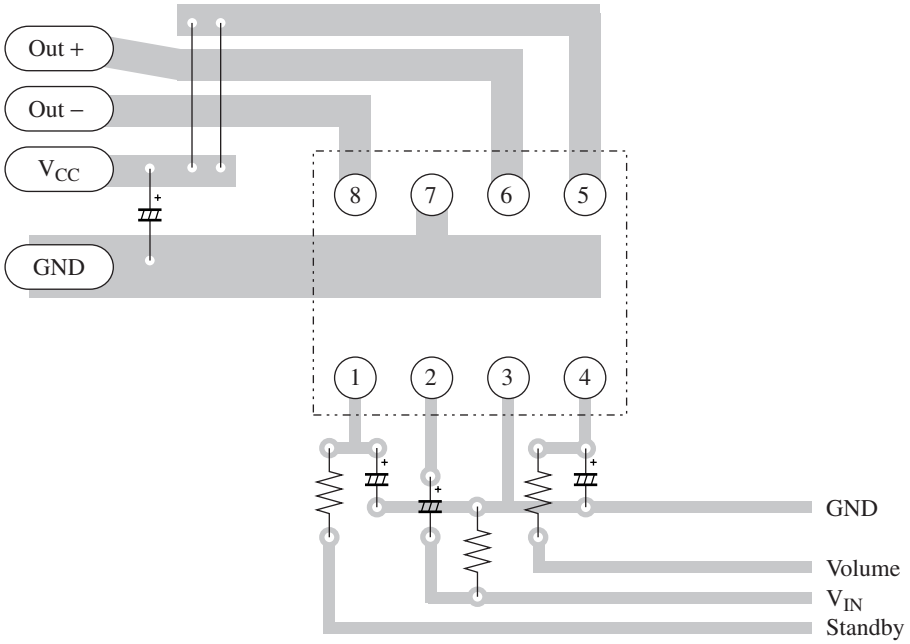
- Please avoid the short circuit to V_{CC} , ground, or load short circuit.
- Please connect the cooling fin with the GND potential.
- The thermal shutdown circuit operates at about T_j = 150°C. However, the thermal shutdown circuit is reset automatically if the temperature drops.
- Please carefully design the heat radiation especially when you take out high power at high V_{CC} .
- Please connect only the ground of signal with the signal GND of the amplifier in the previous stage.

■ Technical Data

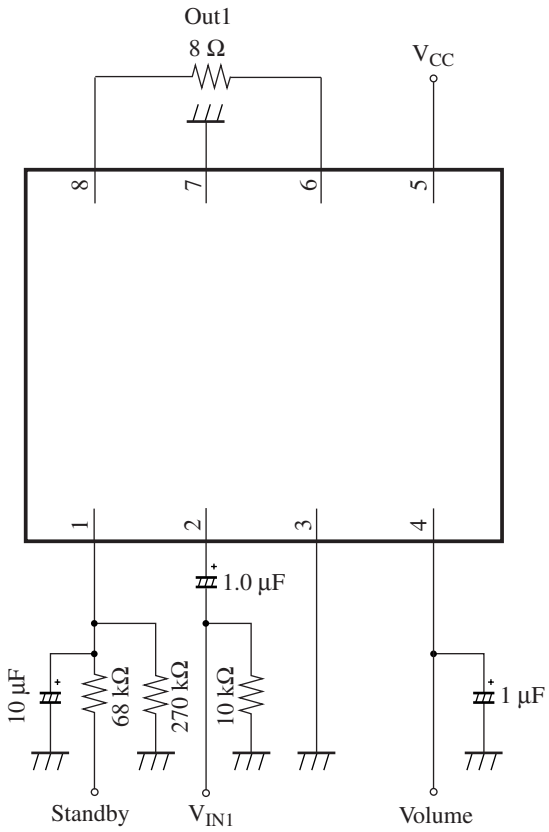
1. Package power dissipation



2. Example of PCB pattern



■ Application Circuit Example



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